

STARPOWER

SEMICONDUCTOR

IGBT

GD15FSA120L2SF

1200V/15A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

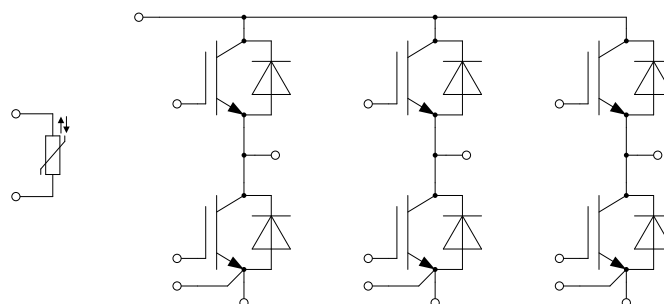
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 8 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology
- PressFIT contact technology
- UL file number:E340089

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_H=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_H=100^{\circ}\text{C}$	15	A
I_{CRM}	Repetitive Peak Collector Current $t_p=1\text{ms}$	30	A

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	15	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	30	A

Module

Symbol	Description	Value	Unit
T_{vjmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{vjop}	Operating Junction Temperature	-40 to +175	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	2500	V
d_{Creep}	Terminal to Heatsink	11.5	mm
	Terminal to Terminal	6.3	
d_{Clear}	Terminal to Heatsink	10.0	mm
	Terminal to Terminal	5.0	
CTI	Comperative Tracking Index	> 175	
RTI	RTI Elec. Housing	120	$^{\circ}\text{C}$
Internal Isolation	Basic Insulation (class 1, IEC 61140)	Al_2O_3	

Note: $T_{vjop} > 150^{\circ}\text{C}$ is allowed for operation at overload conditions.

IGBT Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		1.50	1.95	V
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=125^{\circ}\text{C}$		1.70		
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}$		1.80		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.30\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	5.4	6.2	7.0	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			50	μA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			100	nA
R_{Gint}	Internal Gate Resistance			0		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		1.33		nF
C_{res}	Reverse Transfer Capacitance			0.01		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		94		nC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=25^{\circ}\text{C}$		28		ns
t_r	Rise Time			17		ns
$t_{d(off)}$	Turn-Off Delay Time			175		ns
t_f	Fall Time			209		ns
E_{on}	Turn-On Switching Loss			0.86		mJ
E_{off}	Turn-Off Switching Loss			1.06		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=125^{\circ}\text{C}$		28		ns
t_r	Rise Time			20		ns
$t_{d(off)}$	Turn-Off Delay Time			218		ns
t_f	Fall Time			280		ns
E_{on}	Turn-On Switching Loss			1.10		mJ
E_{off}	Turn-Off Switching Loss			1.43		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=150^{\circ}\text{C}$		28		ns
t_r	Rise Time			20		ns
$t_{d(off)}$	Turn-Off Delay Time			241		ns
t_f	Fall Time			286		ns
E_{on}	Turn-On Switching Loss			1.15		mJ
E_{off}	Turn-Off Switching Loss			1.49		mJ
I_{SC}	SC Data	$t_p \leq 8\mu\text{s}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}, V_{CC}=600\text{V}, V_{CEM} \leq 1200\text{V}$		45		A

Diode Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=15\text{A}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$		1.60	2.05	V
		$I_F=15\text{A}, V_{GE}=0\text{V}, T_{vj}=125^{\circ}\text{C}$		1.65		
		$I_F=15\text{A}, V_{GE}=0\text{V}, T_{vj}=150^{\circ}\text{C}$		1.65		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=970\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=25^{\circ}\text{C}$		0.92		μC
I_{RM}	Peak Reverse Recovery Current			19		A
E_{rec}	Reverse Recovery Energy			0.25		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=860\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=125^{\circ}\text{C}$		1.53		μC
I_{RM}	Peak Reverse Recovery Current			20		A
E_{rec}	Reverse Recovery Energy			0.50		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=810\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=150^{\circ}\text{C}$		1.72		μC
I_{RM}	Peak Reverse Recovery Current			20		A
E_{rec}	Reverse Recovery Energy			0.57		mJ

NTC Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		25		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		4.50		m Ω
R_{thJH}	Junction-to-Heatsink(per IGBT)		1.800		K/W
	Junction-to-Heatsink(per Diode)		2.510		
F	Mounting Force Per Clamp	20		50	N
G	Weight of Module		24		g

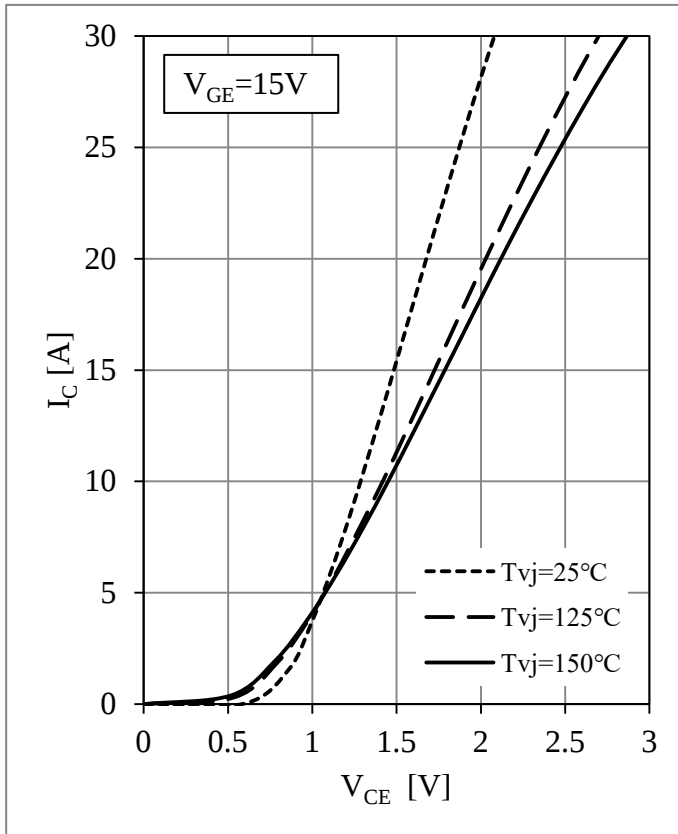


Fig 1. IGBT Output Characteristics

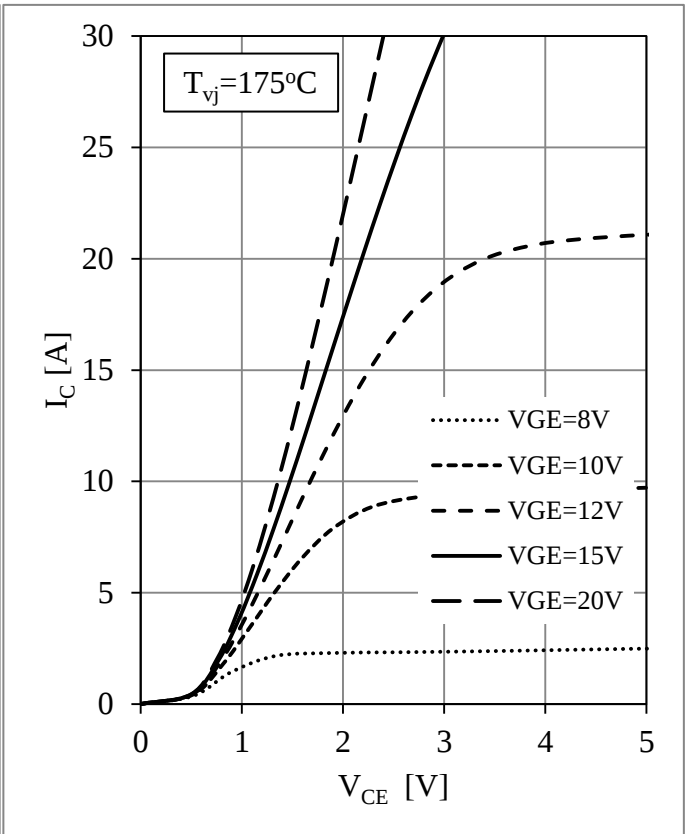


Fig 2. IGBT Output Characteristics

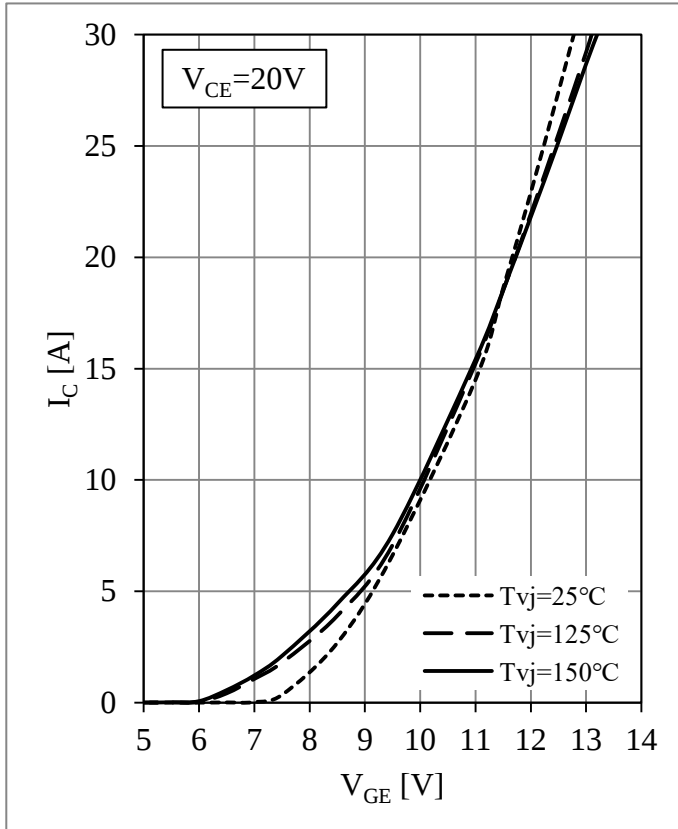
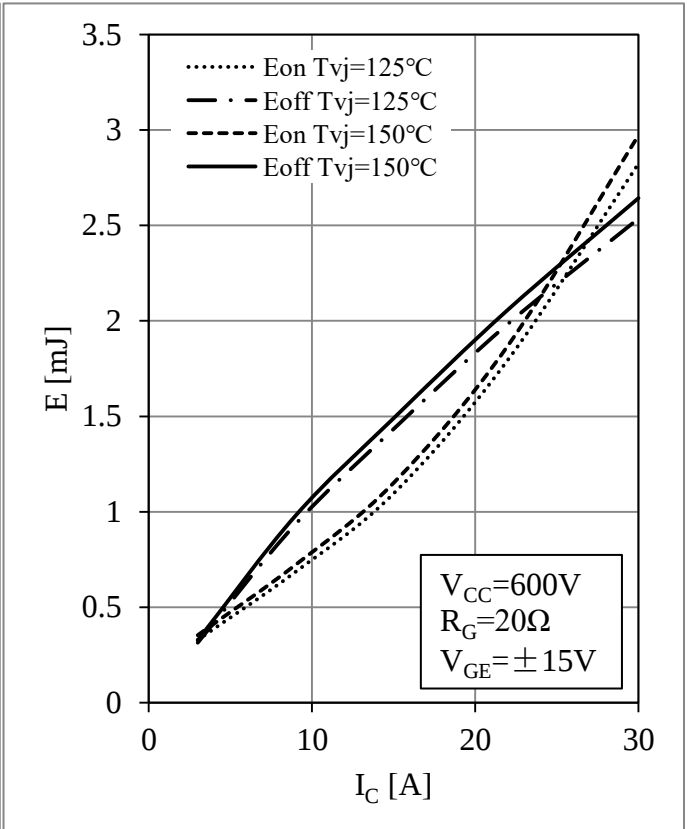
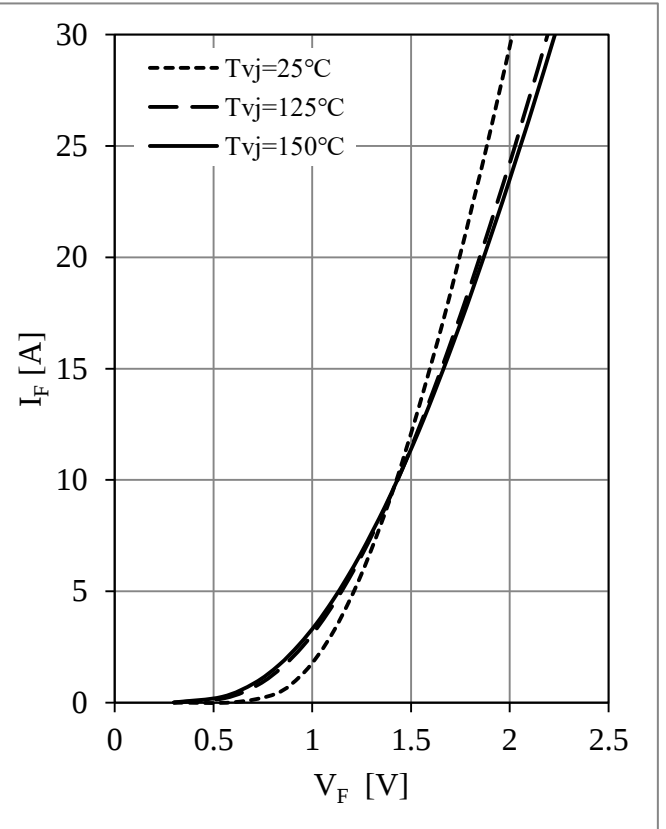
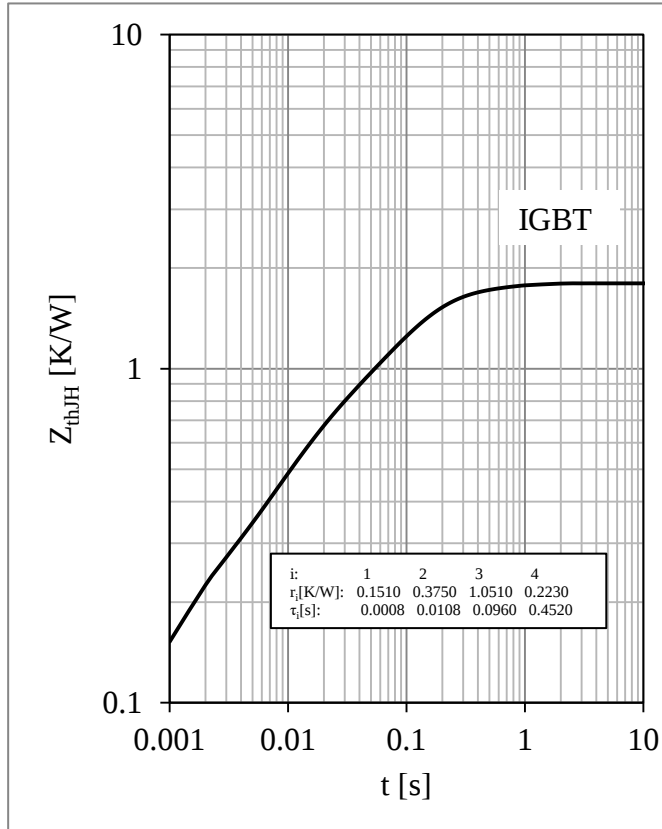
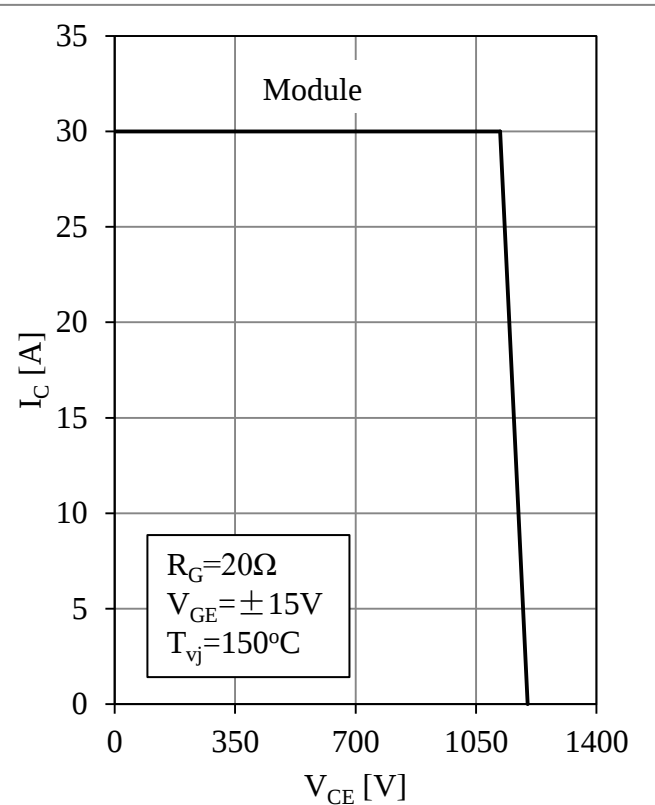
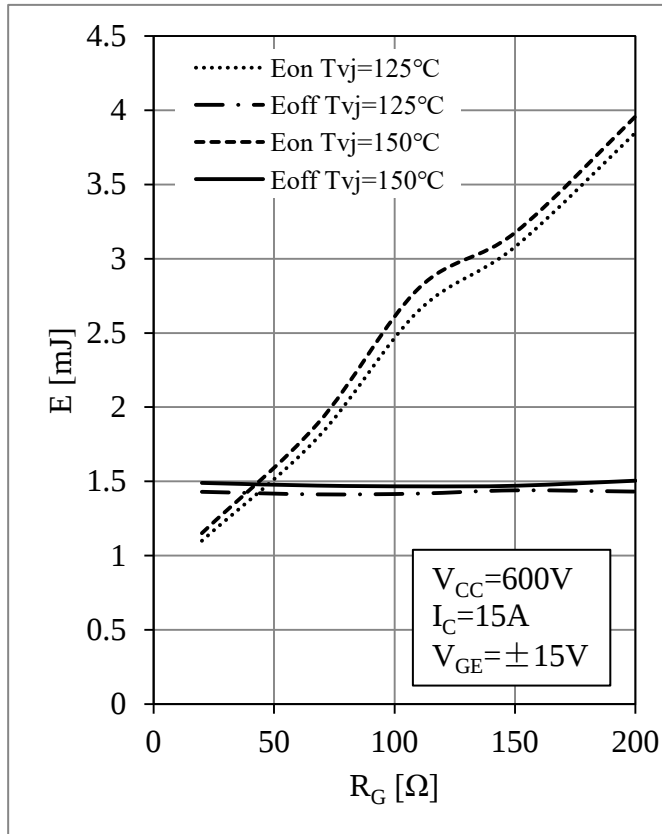


Fig 3. IGBT Transfer Characteristics

Fig 4. IGBT Switching Loss vs. I_C



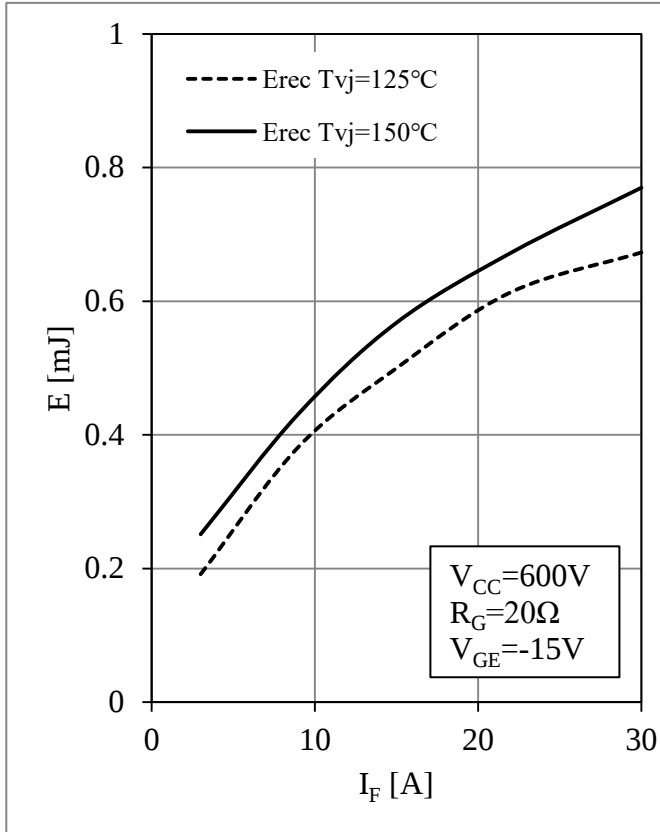
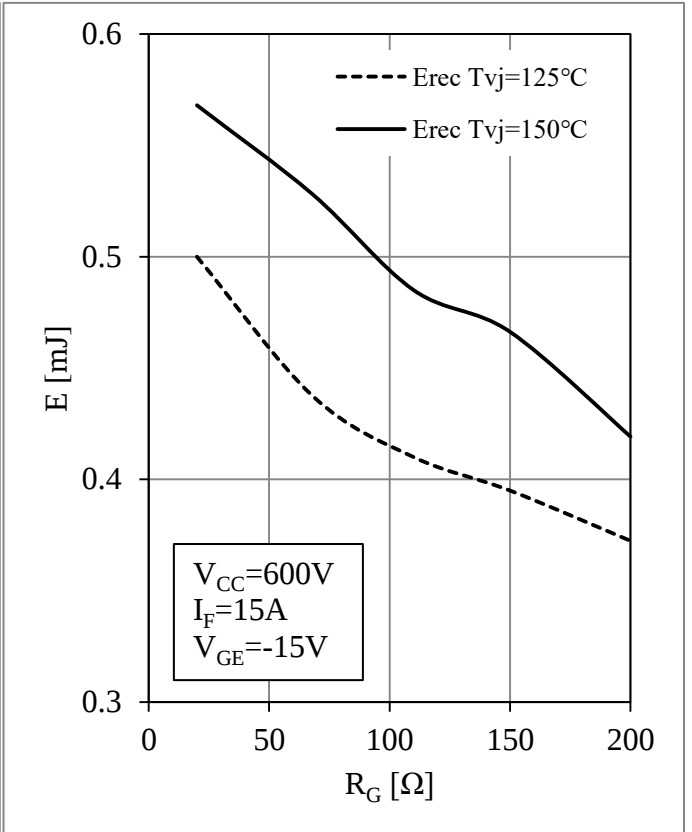
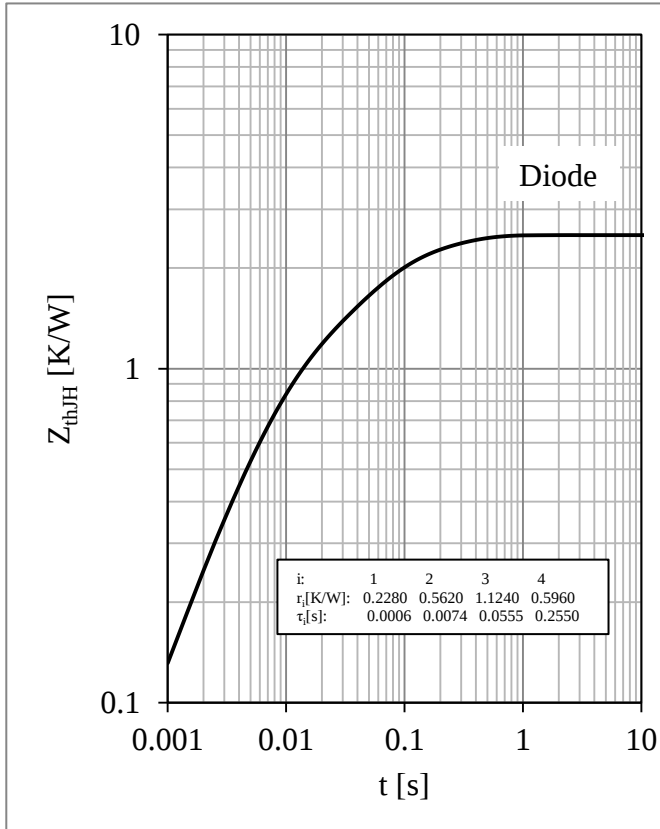
Fig 9. Diode Switching Loss vs. I_F Fig 10. Diode Switching Loss vs. R_G 

Fig 11. Diode Transient Thermal Impedance

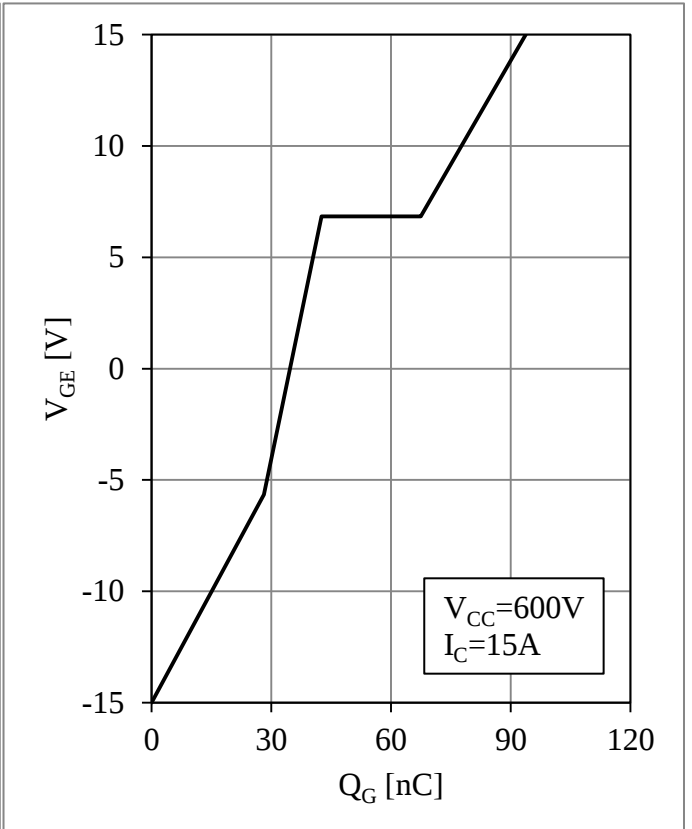


Fig 12. IGBT Gate Charge Characteristic

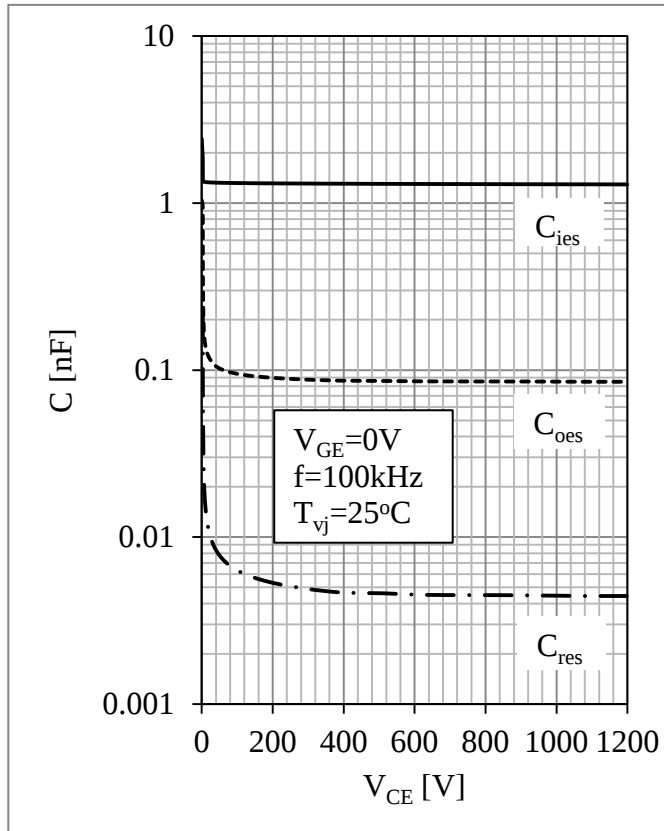


Fig 13. IGBT Capacity Characteristic

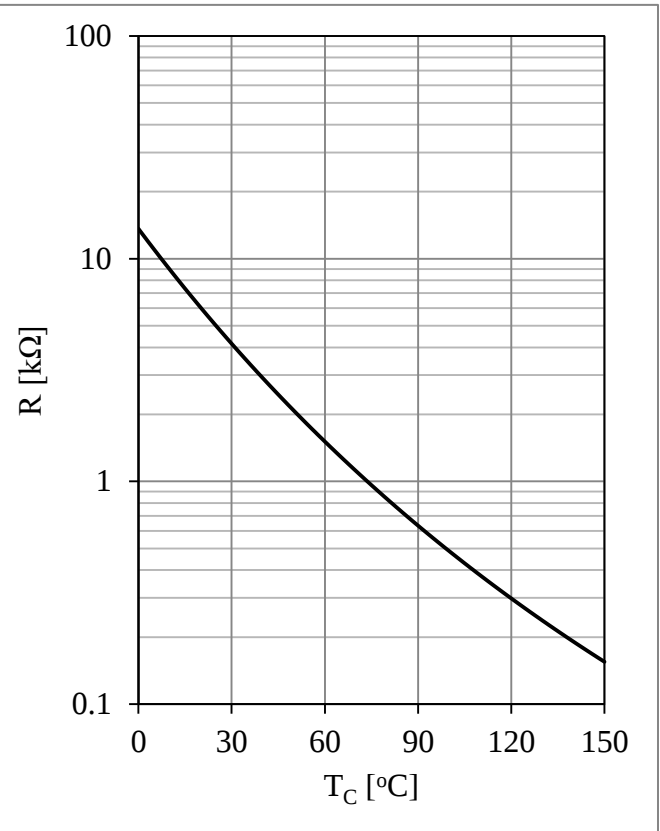
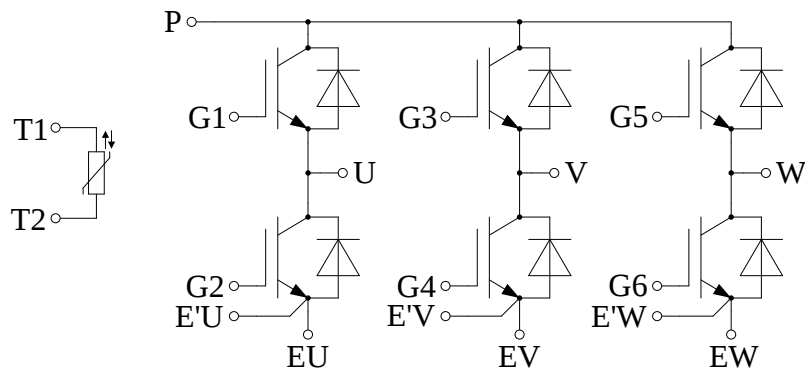


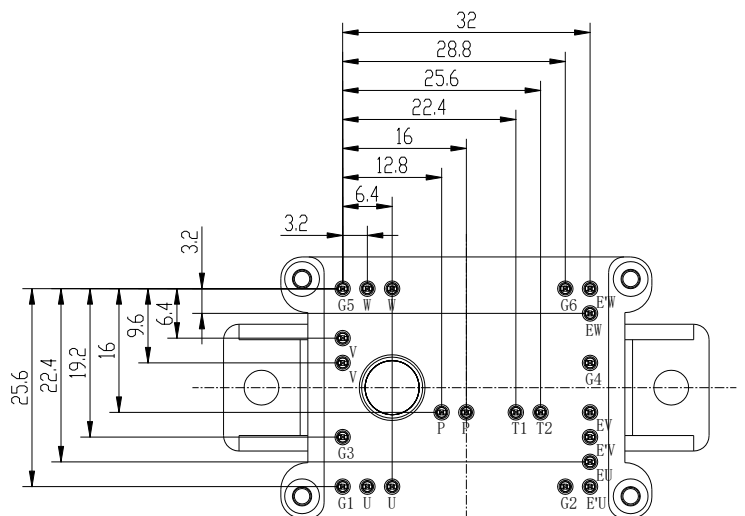
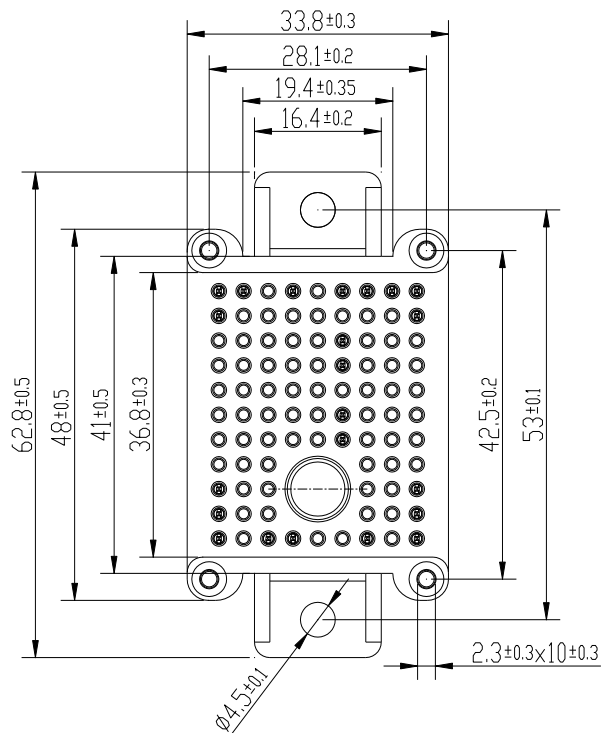
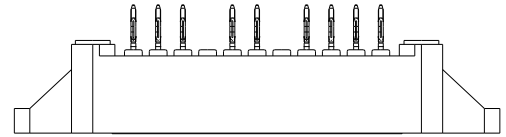
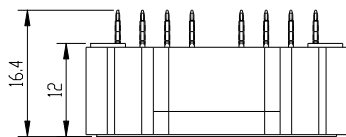
Fig 14. NTC Temperature Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



Pinpositions with tolerance



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